

Applicant : Shunpei Yamazaki et al  
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REMARKS

Claims 1-78 are pending in the application, with claims 1, 11, 21, 32, 43, 47, 51 and 55 being independent. Claims 1-3, 11-13, 21-23, 32, 43-45, 47-49, 51-53 and 55 have been amended and new claims 59-78 have been added. No new matter has been introduced.

Independent claims 1, 11, 43 and 47 have been amended to recite a planarization insulating film formed so as to cover the shielding film and the gate signal line, and independent claims 21 and 51 have been amended to recite a planarization insulating film formed over the lower layer capacitance wiring and the gate signal line. Claim 55 previously recited forming a planarization insulating film by polishing an insulating film that covers a shielding film, a lower layer capacitance wiring and a lower layer wiring.

While paragraph [0054] of JP 11-087726 recites a planarization insulating film 41 formed on the shielding film 3, JP 11-087726 does not describe or suggest a planarization film such as is recited in the amended independent claims. Accordingly, the claims are believed to be allowable over JP 11-087726 for at least this reason.

Applicant asks that all claims be examined in view of the amendments made herein.

Enclosed is a \$1000 check for excess claim fees. Please apply any other charges or credits to deposit account 06-1050.

Respectfully submitted,

Date: 8/30/05

  
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